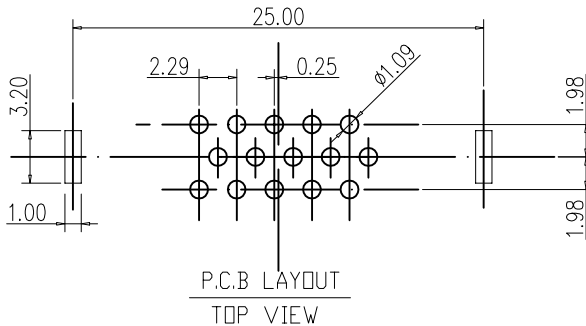
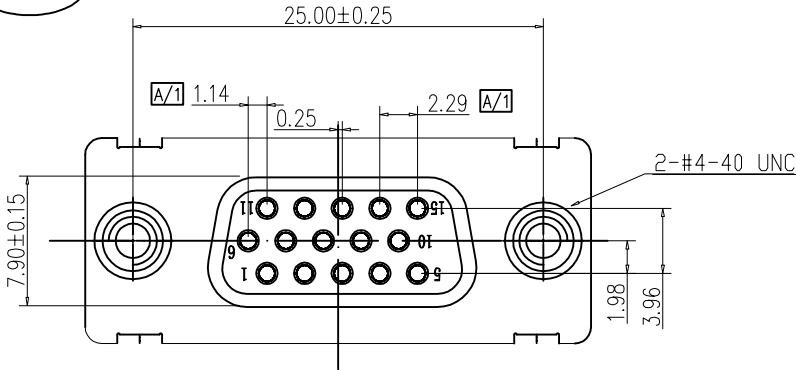
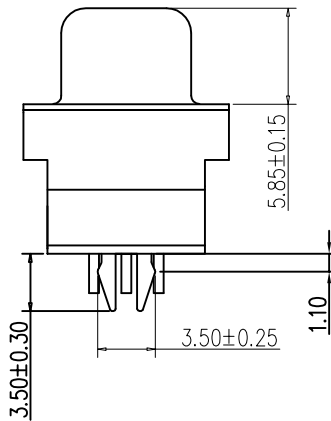
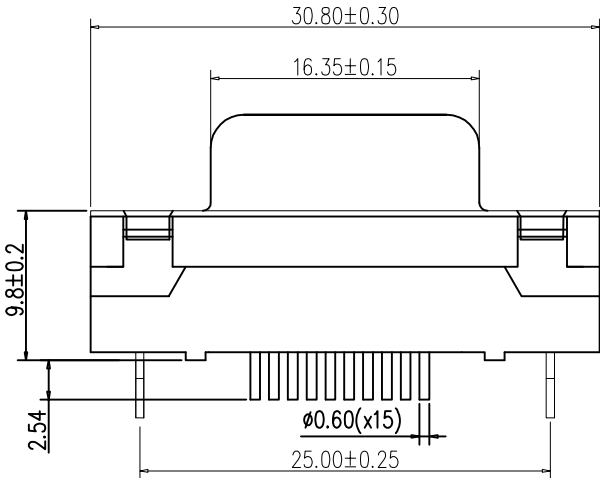


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS



NOTE:
1.MATERIAL:
1.1 HOUSING:PBT. COLOR:BLUE.
1.2 TERMINAL:COPPER ALLOY.
1.3 SHELL:SPCC
1.4 GROUNDING:SPCC
2. PLATING:
2.1 CONTACT: CONTACT:
SELECTIVE GOLD PLATED ON CONTACT AREA
80u" Min. TIN PLATED ON SOLDER TAIL
50u" Min. NICKEL UNDER-PLATED
2.2 SHELL:50u" Min, NICKEL PLATED OVERALL
2.3 GROUNDING:50u" Min, TIN PLATED OVERALL.
3. SPECIFICATIONS:
VOLTAGE: 500 VAC(RMS) MAX.
CURRENT RATING: 3 AMPERE PER CONTACT
CONTACT RESISTANCE: 25 MILLIOHMS MAX.
INSULATION RESISTANCE: 1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING VOLTAGE: 1000V AC(RMS)
VGA TOTAL MATING FORCE: 6.0 KGF MAX.
VGA TOTAL UNMATING FORCE: 1.0 KGF MIN.
MATING FORCE: 5.1Kg.Max.
UNMATING FORCE: 1.0Kg MIN.
OPERATING TEMPERATURE:-25? ~ +85?



P/N: WLDBF0-15 1 X X 0 124
PLATING: 1-G/F COLOUR: G-BLUE

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:		
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	1:1	Wang_jr	21.01.13	WLDBF0-151XX0124	ENDE05		
			UNIT: mm	0.0±0.35	X*REF±6°	APPROVED					TITLE: HDC 15母 铆合 180°DIP 塑高9.8MM PBT防火 外壳四角折弯	
				0.00±0.25	X*±3°	DESIGNER	Han_Gao	21.01.13				
				0.000±0.10	X*X' ±2°	DRAWN	Zijun_Huang	21.01.13				
			SIZE: A4								REV: A0	SHEET: 1/1